

bq27411 EVM: System-Side Impedance Track™ Technology

This evaluation module (EVM) is a complete evaluation system for the bq27411 fuel gauge. The EVM includes one bq27411 circuit module with a current-sense resistor. A separate orderable EV2300 or EV2400 PC interface board for fuel gauge interface along with a PC USB cable, and Microsoft® Windows® based PC software is needed when using this EVM. The circuit module includes one bq27411 integrated circuit and all other onboard components necessary to monitor and predict capacity for a pack-side fuel gauge solution. The circuit module connects directly across the battery cell. With the EV2300 or EV2400 interface board and software, the user can:

- Read the bq27411 data registers
- Update the RAM for different configurations
- Log cycling data for further evaluation
- Evaluate the overall functionality of the bq27411 solution under different charge and discharge conditions

The latest Windows-based PC software can be downloaded from the product folder on the Texas Instruments Web site.

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1 Features

- Complete evaluation system for the bq27411 gas gauge with Impedance Track™ technology
- Populated circuit module for quick setup
- Personal computer (PC) software and interface board for easy evaluation
- Software that allows data logging for system analysis

1.1 Kit Contents

- bq27411 circuit module (PWR544)

This EVM is used for the evaluation of bq27411 fuel gauge. Visit the product Web folder at www.ti.com to properly configure the bq27411 fuel gauge.

1.2 Ordering Information

Table 1. Ordering Information

Part Number	EVM Part Number	Firmware Version ⁽¹⁾	Chemistry	Chemistry ID ⁽²⁾	Configuration
bq27411-G1A	bq27411EVM-G1A	v1.09 (0x0109)	4.2 V Li-ion	128	1 cell
bq27411-G1B	bq27411EVM-G1B	v1.09 (0x0109)	4.3 V Li-ion	312	1 cell
bq27411-G1C	bq27411EVM-G1C	v1.09 (0x0109)	4.35 V Li-ion	354	1 cell

⁽¹⁾ Using the FW_VERSION (0x0002) *Control()* subcommand returns 0x0109. See [SLUSBN7](#), *bq27411-G1x System-Side Impedance Track™ Fuel Gauge*, data sheet for information on *Control()* subcommands.

⁽²⁾ Using the CHEM_ID (0x0008) *Control()* subcommand helps to differentiate between the bq27411-G1A (returns 0x0128), the bq27411-G1B (returns 0x0312), and the bq27411-G1C (returns 0x0354). See [SLUSBN7](#), *bq27411-G1x System-Side Impedance Track™ Fuel Gauge*, data sheet for information on *Control()* subcommands.

2 bq27411-Based Circuit Module

The bq27411-based circuit module is a complete and compact example solution of a bq27411 circuit for battery management. The circuit module incorporates a bq27411 battery fuel gauge integrated circuit (IC) with all other components necessary to accurately predict the capacity of a 1-series Li-ion cell.

2.1 Circuit Module Connections

Contacts on the circuit module provide the following connections:

- Direct connection to the battery cell (J1): CELL+, CELL–
- The serial communications port (J3): SDA, SCL, and VSS
- The load and charger connect across pack connector (J2): PACKP and PACKN
- Access to the programming pin (J7): EXTPROG and VSS
- External connect to I²C pullup voltage (J4): EXTPU and VSS

2.2 Pin Description

Pin Name	Description
PACK+	Charger/load positive terminal
PACK–	Charger/load negative terminal
SDA	I ² C communication data line
EXTPU	External I ² C pullup connection
SCL	I ² C communication clock line
VSS	Signal return for communication line, shared with charger and ground
CELLP	Cell positive terminal
CELLN	Cell negative terminal
EXTPROG	Power connection for OTP programming

3 Circuit Module Physical Layout, Bill of Materials and Schematic

This section contains the board layout, bill of materials, and schematic for the bq27411 circuit module.

3.1 Board Layout

This section shows the printed-circuit board (PCB) layers (Figure 1 through Figure 3), and assembly drawing for the bq27411 module.

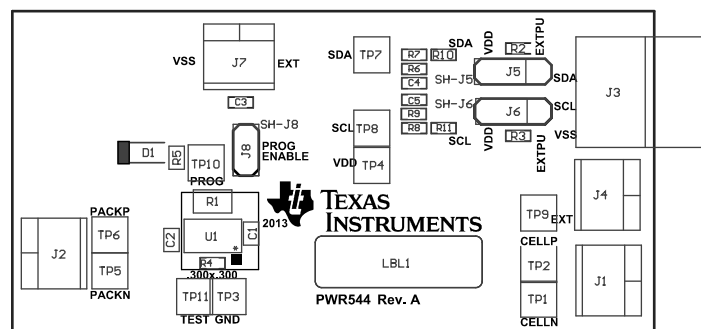


Figure 1. bq27411EVM Layout – Top Silk

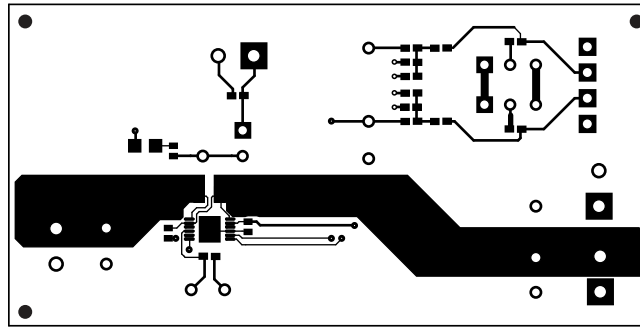


Figure 2. bq27411EVM Layout - Top Layer

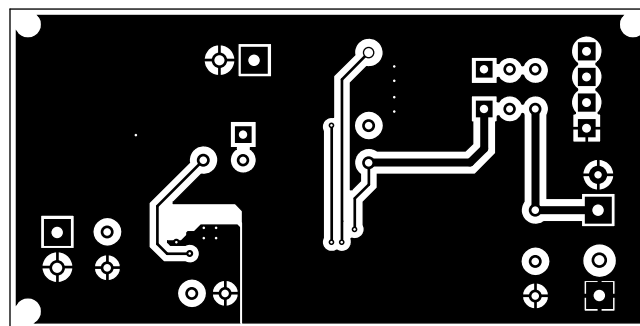


Figure 3. bq27411EVM Layout – Bottom Layer

3.2 Bill of Materials

Table 2. Bill of Materials

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer
PCB	1		Printed Circuit Board		PWR544	Any
C1	1	0.47 μ F	Capacitor, Ceramic Chip, 10V, X5R, \pm 10%	402	C1005X5R1A474K050BB	TDK
C2	1	1.0 μ F	Capacitor, Ceramic Chip, 16V, X5R, \pm 10%	402	C1005X5R1C105K050BC	TDK
C3	1	1 μ F	Capacitor, CERM, 1 μ F, 10V, \pm 10%, X5R, 0402	0402	GRM155R61A105KE15D	MuRata
C4, C5	2	150 pF	Capacitor, CERM, 150pF, 50V, \pm 5%, C0G/NP0, 0402	0402	GRM1555C1H151JA01D	MuRata
D1	1	Red	LED, Red, SMD	LED_0805	LTST-C170KRKT	Lite-On
J1, J2, J4, J7	4	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED555/2DS	OST
J3	1	22-05-3041	Header, Friction Lock Ass'y, 4-pin Right Angle	0.400 x 0.500 inch	22-05-3041	Molex
J5, J6	2	PEC03SAAN	Header, Male 3-pin, 100mil spacing	0.100 inch x 3	PEC03SAAN	Sullins
J8	1	PEC02SAAN	Header, Male 2-pin, 100mil spacing	0.100 inch x 2	PEC02SAAN	Sullins
LBL1	1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H, 10,000 per roll	PCB Label 0.650"H x 0.200"W	THT-14-423-10	Brady
R1	1	0.010	Resistor, Power Metal Strip, 0.25W, 1%	805	WSL0805R0100FEA1	Vishay
R2, R3	2	5.1 k Ω	Resistor, 5.1 k Ω , 5%, 0.063W, 0402	0402	CRCW04025K10JNED	Vishay-Dale
R4, R6, R9	3	1.00 M Ω	Resistor, 1.00 M Ω , 1%, 0.063W, 0402	0402	CRCW04021M00FKED	Vishay-Dale
R5	1	510	Resistor, 510 Ω , 5%, 0.063W, 0402	0402	CRCW0402510RJNED	Vishay-Dale
R7, R8	2	300	Resistor, 300 Ω , 5%, 0.063W, 0402	0402	CRCW0402300RJNED	Vishay-Dale
R10, R11	2	100	Resistor, 100 Ω , 1%, 0.063W, 0402	0402	CRCW0402100RFKED	Vishay-Dale
SH-J5, SH-J6, SH-J8	3	1x2	Shunt, 100mil, Gold plated, Black	Shunt	969102-0000-DA	3M
TP1, TP5, TP11	3	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
TP2, TP4, TP6, TP9, TP10	5	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
TP3, TP7, TP8	3	5002	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
U1	1	BQ27411DRZ-G1x	IC, Single-Cell Impedance Track Gas Gauge	QFN12	BQ27411DRZ-G1x	TI

3.3 Schematic

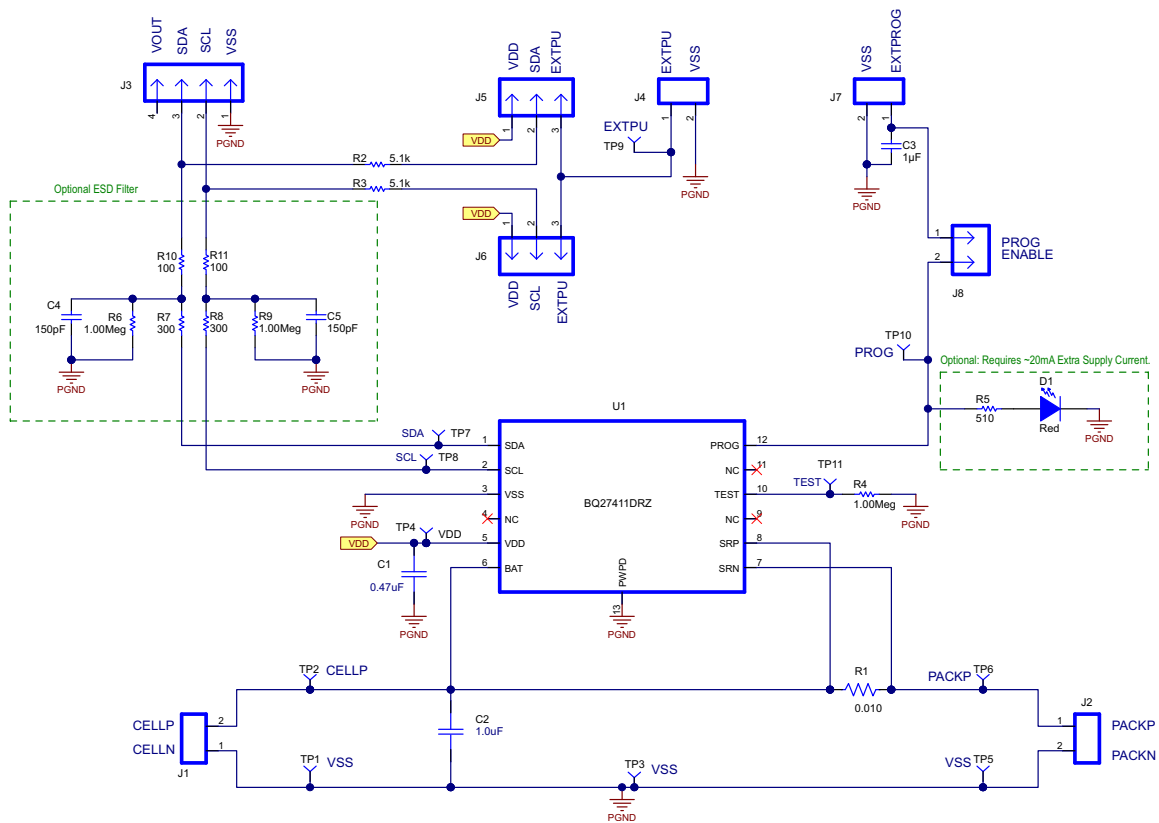


Figure 4. bq27411EVM Schematic

3.4 bq27411 Circuits Module Performance Specification Summary

Table 3 summarizes the performance specifications of the bq27411 circuit module.

Table 3. Performance Specification Summary

Specification	Min	Typ	Max	Unit
Input voltage Pack+ to Pack-	2.7	3.6	5	V
Charge and discharge current	0	1	6	A

4 EVM Hardware and Software Setup

This section describes how to install the bq27411EVM PC software and how to connect the different components of the EVM.

4.1 Software Installation

Find the latest software version at <http://www.ti.com/tool/bqStudio>. Use the following steps to install Battery Management Studio:

1. Ensure that the EV2300 is not connected to the PC through a USB cable before starting this procedure.
2. Select the *Tool and Software* tab in the product folder.
3. Under the *Software* section, click on *Battery Management Studio (bqStudio) Software Suite*.
4. Click the **Download** button to download the software.
5. Download software to hard drive.
6. Double-click the software executable and follow all instructions and prompts.

5 Troubleshooting Unexpected Dialog Boxes

The user that is downloading the files must be logged in as the administrator. The driver is not signed, so the administrator must allow installation of unsigned drivers in the operating system. If using Windows 7, install the software with administrator privileges.

6 Hardware Connection

The bq27411 evaluation system comprises three hardware components: the bq27411 circuit module, the EV2300 or EV2400 PC interface board, and the PC.

6.1 Connecting the bq27411 Circuit Module to a Battery Pack

Figure 5 shows how to connect the bq27411 circuit module to the cells and system load/charger.

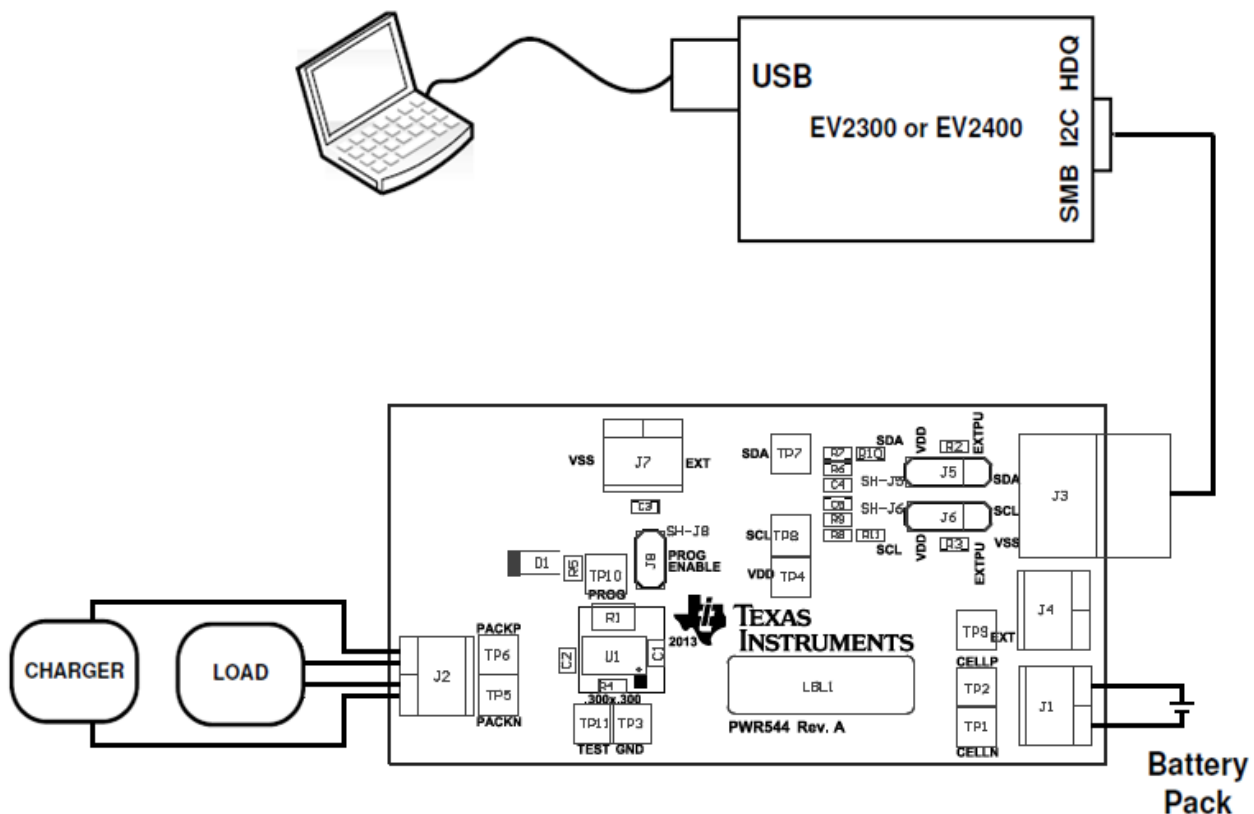


Figure 5. bq27411 Circuit Module Connection to Pack and System Load/Charger

6.2 PC Interface Connection

The following steps configure the hardware for interface to the PC.

1. Connect the bq27411-based EVM to the EV2300 or EV2400 using wire leads as shown in [Table 4](#).
2. Connect the PC USB cable to the EV2300 or EV2400 and the PC USB port.

Table 4. Circuit Module to EV2300 or EV2400 Connections

bq27411EVM	EV2300 or EV2400
SDA	SDA
SCL	SCL
VSS	GND/VSS

The bq27411EVM is now set up for operation.

7 Operation

This section details the operation of the bqStudio software.

7.1 Starting the Program

Run bqStudio from the Start | All Programs | Texas Instruments | Battery Management Studio. The main screen ([Figure 6](#)) appears. If instead of [Figure 6](#) appearing, [Figure 7](#) appears, it may mean that the EVM is not connected to the computer correctly. Make sure that the USB interface (EV2300 or EV2400 or GDK) and the bq27411 are connected and restart bqStudio. If this still does not resolve the issue, check if the I2C pullup resistors are connected. Data begins to appear once the <Refresh> (single-time scan) button is clicked, or when the Scan button is clicked. To disable the scan feature, simply click the **Scan** button again.

The continuous scanning period can be set by opening Window | Preferences → Registers section. The range for this interval is 0 ms to 65,535 ms. Only items that are selected for scanning are scanned within this period.

Battery Management Studio provides a logging function which logs the values that were last scanned. To enable this function, select the Start Log button; this causes the Scan button to be pressed. When logging is Stopped, the Scan button will still be selected and has to be manually clicked again.

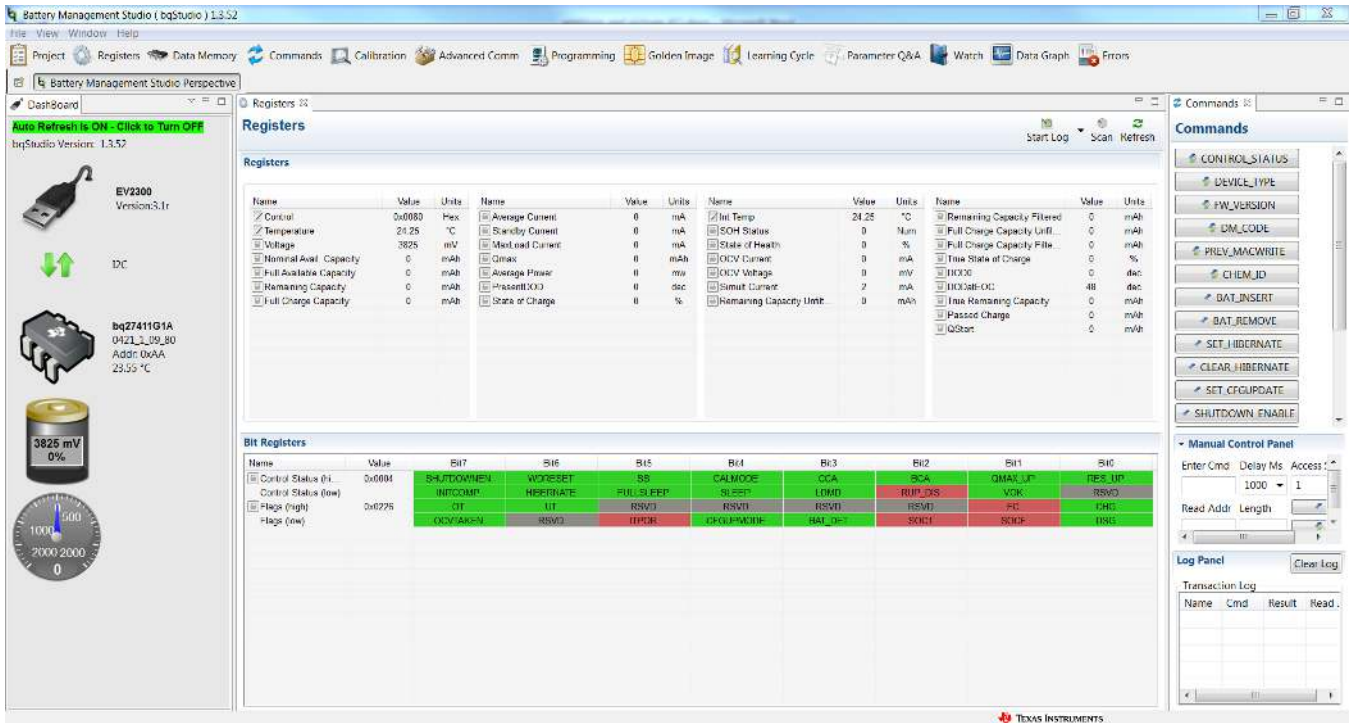


Figure 6. Registers Screen

This screen (Figure 6) shows the RAM data in the bq27411 device. Additional Flags and Status data can be viewed at the bottom of the *Registers* screen.

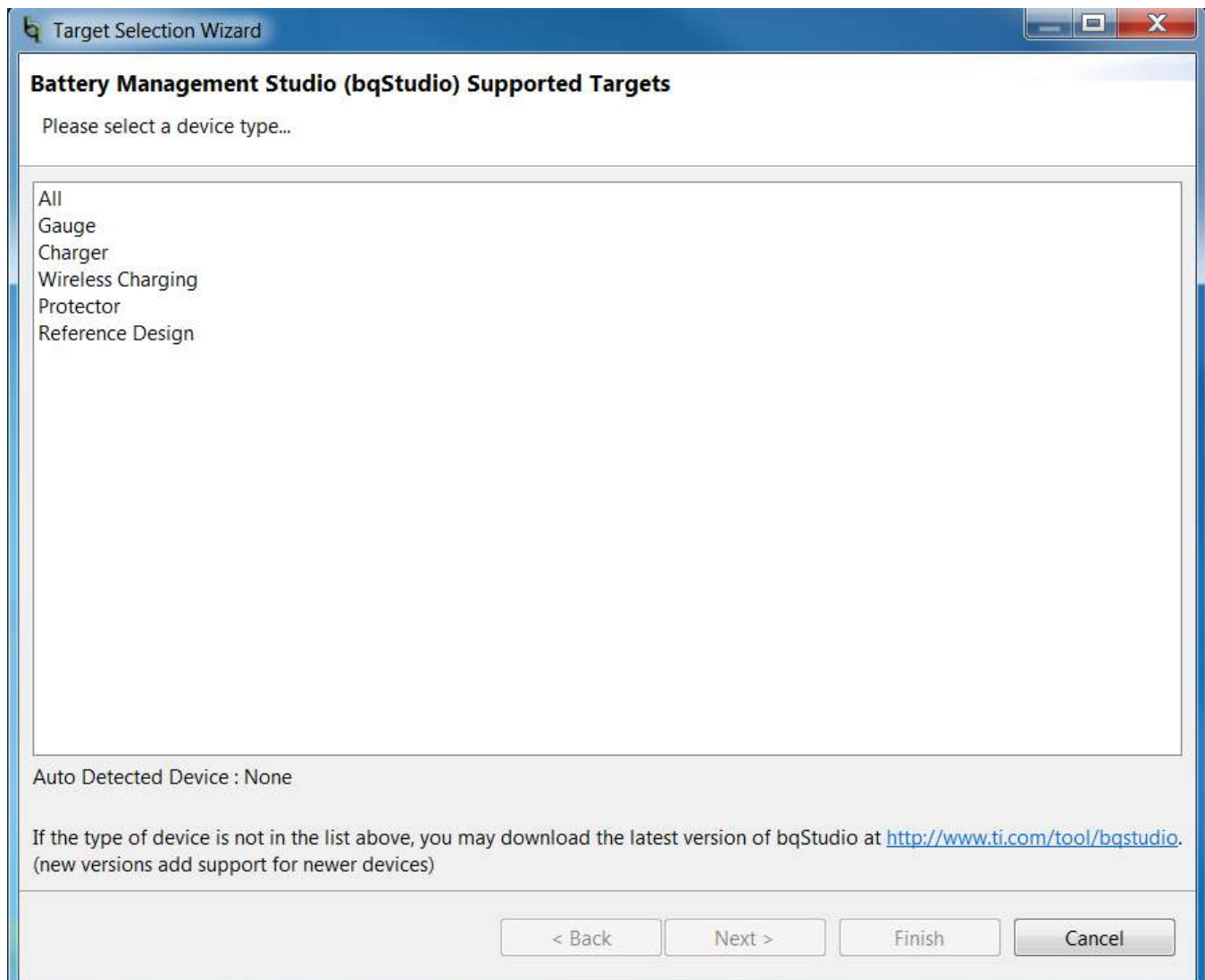


Figure 7. bqStudio Default Page

7.2 Setting Programmable bq27411 Options

The bq27411 data memory comes configured per the default settings detailed in the bq27411 technical reference manual (SLUUAS7). Ensure that the settings are correctly changed to match the pack and application for the bq27411 solution being evaluated.

IMPORTANT: The correct setting of these options is essential to get the best performance. The settings can be configured using the *Data Memory* screen (Figure 8).

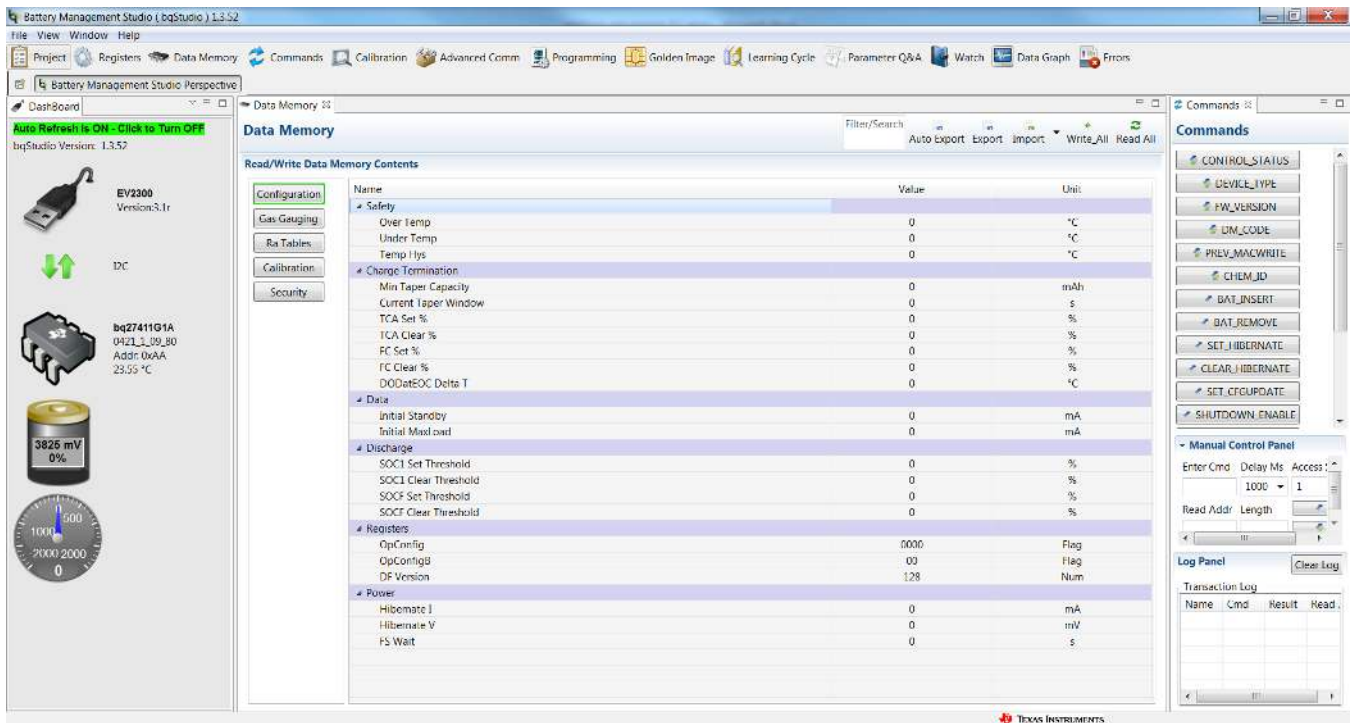


Figure 8. Data Memory Screen

To read all the data from the bq27411 non-volatile flash memory, click on the **Read All** button on the *Data Memory* window. Make sure the device is not sealed and in full access to read or write to the data memory. To update a parameter, click on the desired parameter and a window pops-up that provides details on the selected parameter. Next, enter the value in the value textbox and press **Enter**. After pressing **Enter**, bqStudio updates the selected parameter. The **Import** button in the *Data Memory* window can be clicked in order to import an entire configuration from a specified *.gg.csv file.

Save the configuration to a file by clicking the **Export** button in the *Data Memory* window and entering a file name. The configuration is saved to a *.gg.csv file. The module calibration data is also held in the bq27411 data memory. If the Gauge Dashboard is not displaying any information, then the bq27411 may not be supported by the bqStudio version being used, a bqStudio upgrade may be required.

8 Calibration

The bq27411EVM must be calibrated to ensure accurate value reporting. This can be done by going to the *Calibration* window in bqStudio (Figure 9).

8.1 Calibrating the bq27411

1. Select the types of calibration to be performed (see Figure 9).
2. Enter the measured values for the types selected.
3. Press the button to calibrate.

8.2 Voltage Calibration

Voltage calibration usually is not required. If needed, follow these steps:

1. Measure the voltage across Pack+ and Pack–.
2. Type the voltage value in mV into *Enter measured value*.
3. Press the **Calibrate** button.

8.3 Board Offset Calibration

This performs the offset calibration for the current offset of the board.

It is expected that no current is flowing through the sense resistor while performing this calibration step.

1. Remove load and short PACK– to LOAD–.
2. Press the **Calibrate** button.

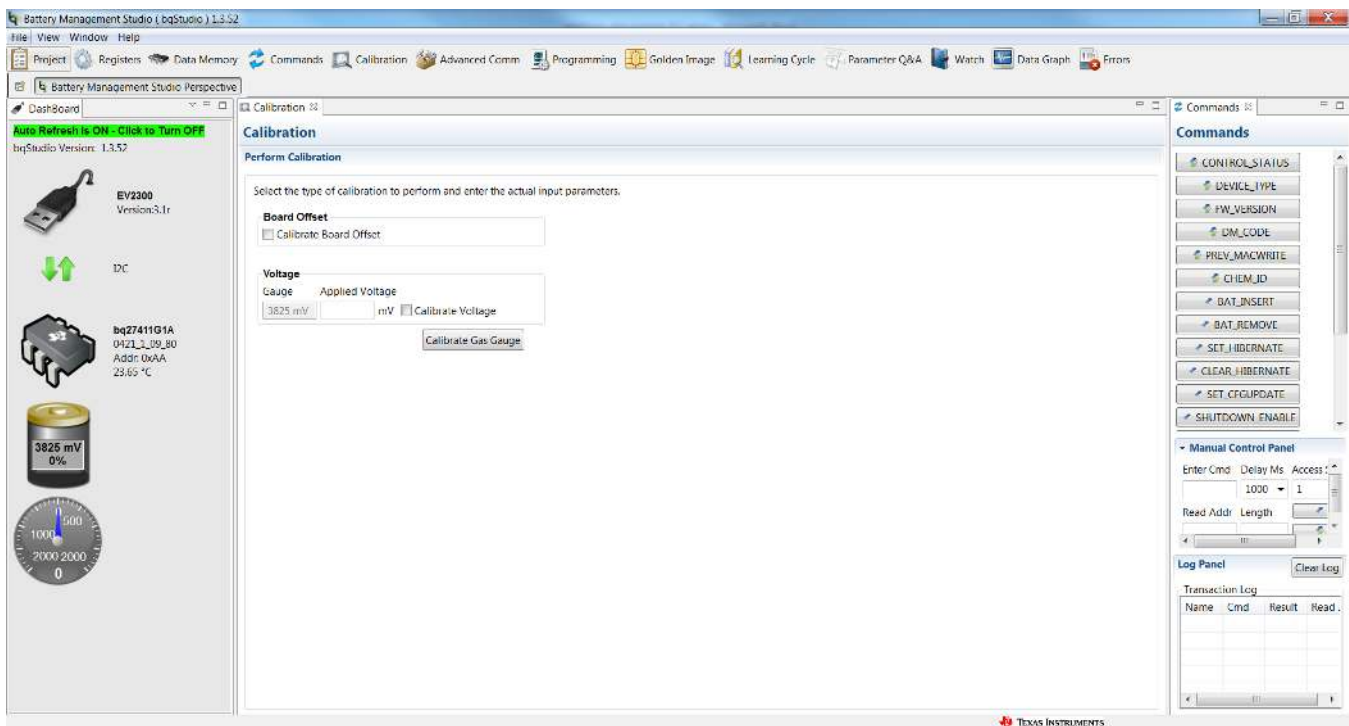


Figure 9. Calibration Screen

9 Related Documentation from Texas Instruments

To obtain a copy of any of the following TI documents, call the Texas Instruments Literature Response Center at (800) 477-8924 or the Product Information Center (PIC) at (972) 644-5580. When ordering, identify this document by its title and literature number. Updated documents also can be obtained through the TI Web site at www.ti.com.

1. *bq27411-G1 System-Side Impedance Track™ Fuel Gauge* data sheet ([SLUSBN7](#))
2. *bq27411-G1 System-Side Impedance Track™ Fuel Gauge* Technical Reference Manual ([SLUUAS7](#))
3. *SmartFlash OTP Programming* (SLUA703)

Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (January 2014) to A Revision

Page

- | | |
|---|----|
| • Deleted <i>System Requirements</i> and rewrote <i>Software Installation</i> sections in <i>EVM Hardware and Software Setup</i> | 7 |
| • Changed the entire <i>Operation</i> section, text and images. | 8 |
| • Changed <i>Calibrate Screen</i> section to <i>Calibration</i> section, and changed some text and the image in that section. | 12 |
-

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3. *Regulatory Notices:*
 - 3.1 *United States*
 - 3.1.1 *Notice applicable to EVMs not FCC-Approved:*

This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.
 - 3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

3.3 Japan

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/lstds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required by Radio Law of Japan to follow the instructions below with respect to EVMs:

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/llds/ti_ja/general/eStore/notice_02.page

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4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

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